Single-chip Type with Built-in FET Switching Regulator Series

1.0A, Step-down Switching regulators with Built-in Power MOSFET

BU90104GWZ

●General Description

The BU90104GWZ are a high efficiency 6MHz synchronous step-down switching regulator with ultra low current PFM mode.
It provides up to 1.0A load current and an input voltage range from 3.0V to 5.5V, optimized for battery powered portable applications.
BU90104GWZ has a mode control pin that allows the user to select Forced PWM(Pulse Width Modulation) mode or PFM(Pulse Frequency Modulation) and PWM auto change mode utilized power save operation at light load current.

●Features

- Fast transient response
- Automatic PFM/PWM operation
- Forced PWM operation
- Internal Soft Start
- Under voltage lockout
- Over current protection
- Thermal shutdown

●Applications

Smart phones, Cell phones, Portable applications and Micro DC/DC modules, USB accessories

●Package(s)

	W(Typ.) x D(Typ.) x H(Max.)
UCSP35L1	1.30mm x 0.90mm x 0.40mm

●Typical Application Circuit(s)

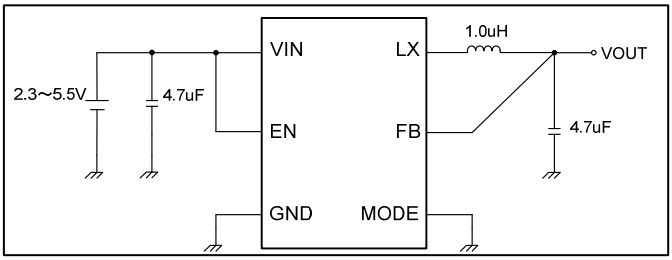


Figure 1. Typical Application Circuit(s)

●Lineup

Part No.	Output voltage	Input voltage	Switching frequency	Operating mode	
				MODE=L	MODE=H
BU90104GWZ	1.80V	2.3V to 5.5V	4.8MHz to 6.0MHz	Automatic PFM/PWM	Forced PWM

●Pin Configuration(s)

(BOTTOM VIEW)

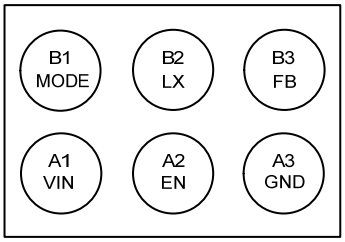


Figure 2. Pin Configuration(s)

●Pin Description(s)

Pin No.	Symbol	Function
A1	VIN	Power supply input pin
A2	EN	Enable pin
A3	GND	GND pin
B1	MODE	Forced PWM mode pin
B2	LX	Inductor connection pin
B3	FB	Feedback voltage input pin

●**Block Diagram(s)**

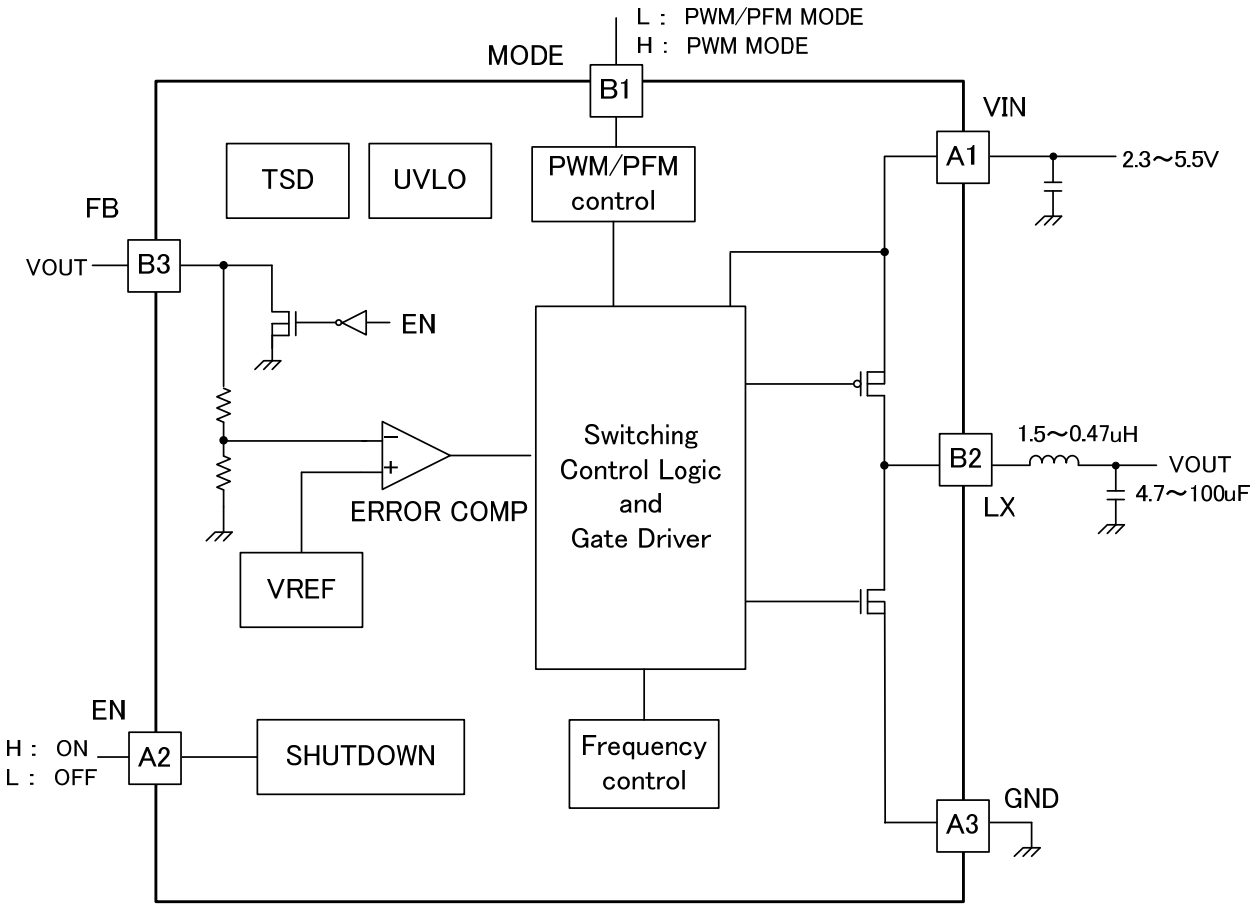


Figure 3. Block Diagram(s)

●**Description of Block(s)**

The BU90104GWZ are a synchronous step-down DC/DC converter that achieves fast transient response from light load to heavy load by hysteretic PWM control system and current constant PFM control system.

○PWM control

BU90104GWZ operates by hysteretic PWM control. This scheme ensures fast switching, high efficiency, and fast transient response.

When the output voltage is below the VREF voltage, the error comparator output is low to high and turning on P-channel MOSFET until above the VREF voltage and minimum on time.

○PFM control

At light load the regulator and MODE=low, the regulator operates with reduced switching frequency and improves the efficiency. During PFM operation, the output voltage slightly higher than typical output voltage.

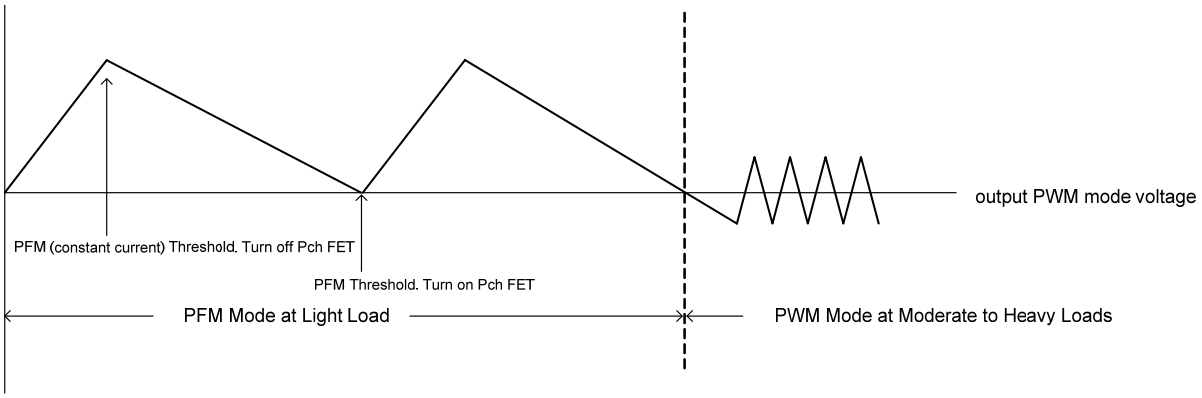


Figure 4. Operation of PFM mode and PWM mode

●Description of operations

1) Shutdown

If the EN input pin set to low (<0.4V), all circuit are shut down and the regulator is standby mode. Do not leave the EN pin floating.

2) Soft start function

The regulator has a soft start circuit that reduces in-rush current at start-up. Typical start up times with a 4.7uF output capacitor is (400usec).

3) Current limit

The BU90104GWZ has a current limit circuit that protects itself and external components during overload condition.

4) UVLO

The BU90104GWZ has an Under Voltage Lock Out circuit that turn off device when VIN>2.05V(typ.)

5) FORCED PWM MODE

Setting MODE pin high (>1.4V) places the regulator in forced PWM.This control provides noise reduction and output stability. Do not leave the MODE pin floating.

6) TSD

The BU90104GWZ has a thermal shutdown feature to protect the device if the junction temperature exceeds 150℃.
In thermal shutdown, the DRIVER is disabled.
This circuit is only to cut off the IC from thermal runaway, and has not been design to protect or guarantee the IC.
Therefore, the user should not plan to activate this circuit with continued operation in mind.

●Absolute Maximum Ratings (Ta=25℃)

Parameter	Symbol	Rating	Unit
Maximum input power supply voltage	VIN	7	V
Maximum voltage at EN, FB, LX, MODE	VEN, VFB, VLX, VMODE	7	V
Power dissipation	Pd	0.39 *1	W
Operating temperature range	Topr	-40 to +85	℃
Storage temperature range	Tstg	-55 to +125	℃
Junction temperature	Tjmax	+125	℃

(*1) When mounted on the specified PCB (55mm x 63mm), Deducted by 3.9m W/c when used over Ta=25c

●Recommended Operating Rating(s)

Parameter	Symbol	Rating			Unit
		Min.	Typ.	Max.	
Input voltage	VIN	2.3	-	5.5	V

●**Electrical Characteristic(s)** (unless otherwise specified VIN=3.6V, Ta=25℃)

Item		Symbol	Rating			Unit	Condition
			Min.	Typ.	Max.		
【Switching regulator】							
Output voltage accuracy		VOUTA	1.764	1.800	1.836	V	MODE:H(PWM Operation)
			1.764	1.800	1.854		MODE:L(PFM Operation)
Maximum load current		IoutMAX1	-	-	1.0	A	3.0V≦VIN＜5.5V
		IoutMAX2	-	-	0.8	A	2.7V≦VIN＜3.0V
		IoutMAX3	-	-	0.6	A	2.3V≦VIN＜2.7V
【Soft start】							
Soft start time		Tss	200	400	800	usec	
【Frequency control】							
Switching frequency		fosc	4.8	5.4	6.0	MHz	No load, MODE:H
【Driver】							
PchFET on resistance		RonP1	-	250	400	mOhm	VIN=5.0V
		RonP2		300	450	mOhm	VIN=3.6V
NchFET on resistance		RonN1	-	220	350	mOhm	VIN=5.0V
		RonN2		250	380	mOhm	VIN=3.6V
【Control】							
EN pin control voltage	Operation	VENH	1.4	-	VIN	V	
	Non Operation	VENL	0	-	0.4	V	
MODE pin control voltage	Operation	VMODEH	1.4	-	VIN	V	Forced PWM
	Non Operation	VMODEL	0	-	0.4	V	Automatic PFM/PWM
【UVLO】							
Protect threshold voltage		Uvth	1.95	2.05	2.15	V	
Hysteresis		Uvhy	50	100	150	mV	
【Current limit】							
Current limit threshold		ILIMIT	1.5	1.7	1.9	A	PMOS current detect, Open loop
【Output discharge】							
Output discharge resistance		DRES	15	30	60	Ohm	EN=0V
【Circuit current】							
Operating quiescent current		IINS1	-	45	65	uA	EN:H, MODE:L, VOUT=3.6V forced Not switching
Shutdown current		SHD	-	0	1	uA	EN=0V

●**Electrical characteristic curves** (Reference data)
Parts
L:LQM21MPN1R0NG0 (2.0mm × 1.6mm × 1.0mm Murata)
COUT:GRM155R60J475M(1.0mm × 0.5mm × 0.5mm Murata)

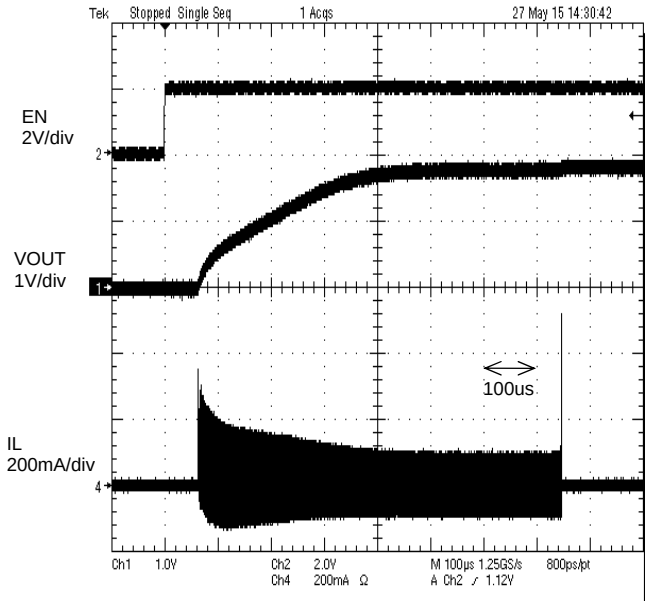


Figure 5. Start up

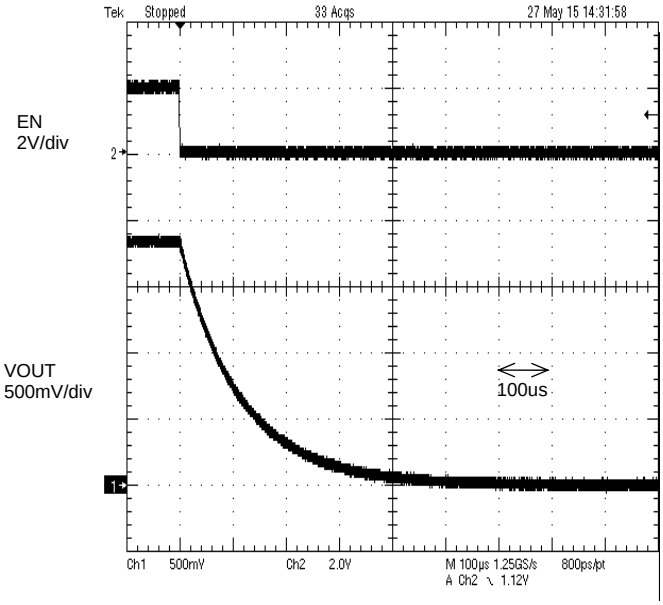


Figure 6. Shut down

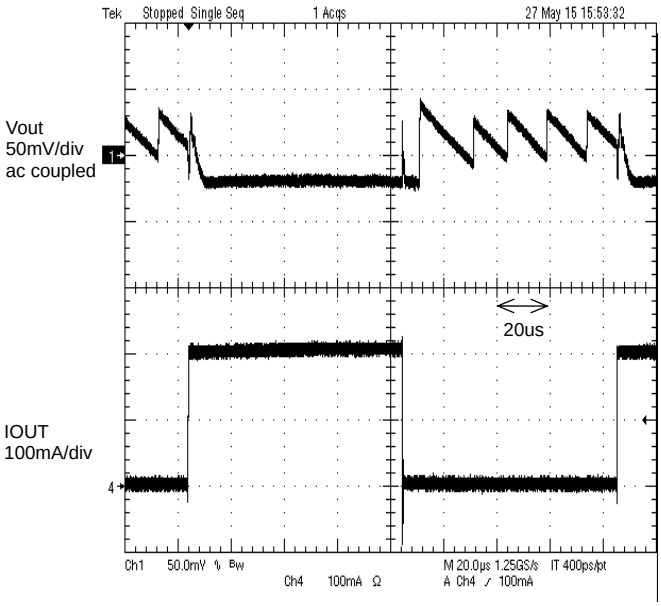


Figure 7. Load transient response 5mA to 50mA
tr=tf=100ns, MODE : Low

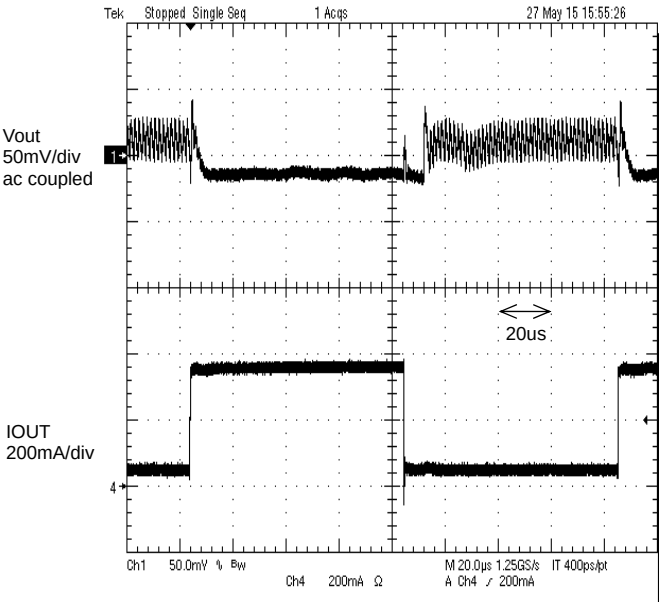


Figure 8. Load transient response 50mA to 350mA
tr=tf=100ns, MODE : Low

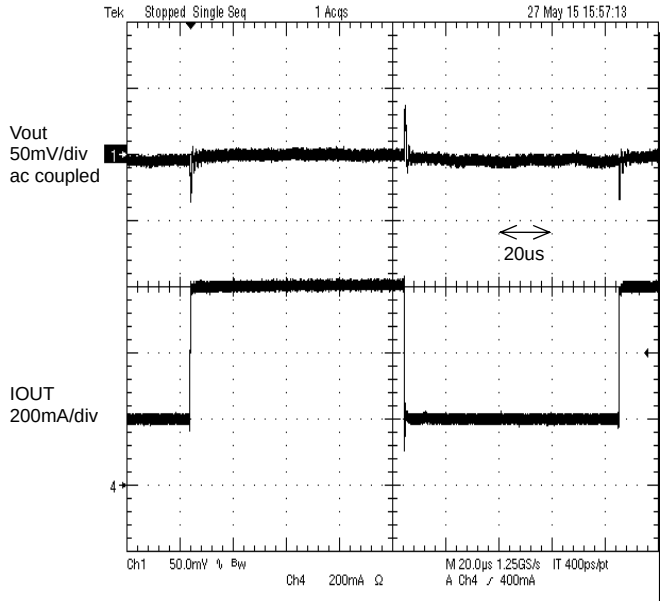


Figure 9. Load transient response 150mA to 500mA
tr=tf=100ns, MODE : High

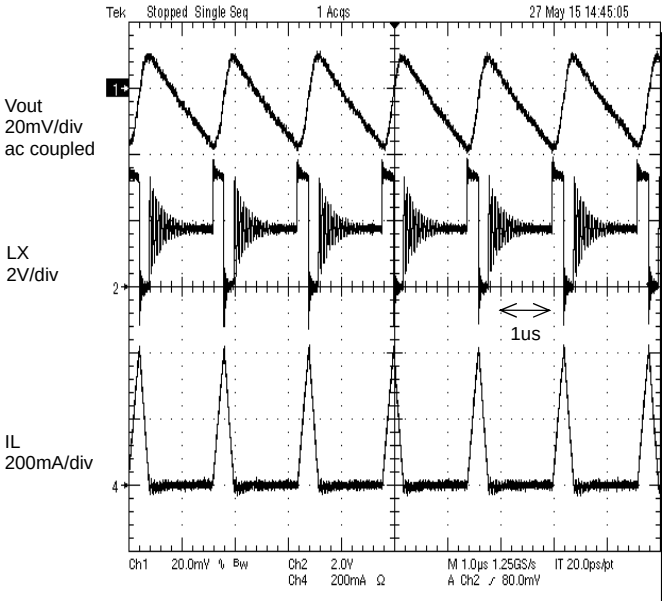


Figure 10. PFM mode Operation
Iout=50mA

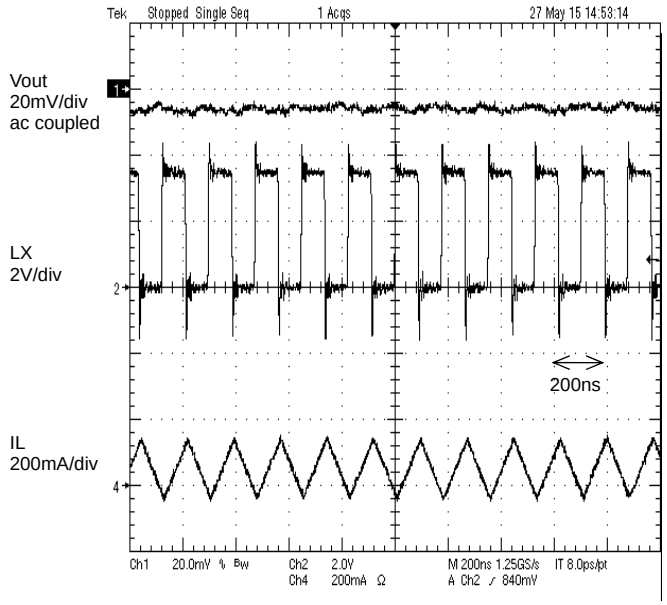


Figure 11. PWM mode Operation
Iout=100mA

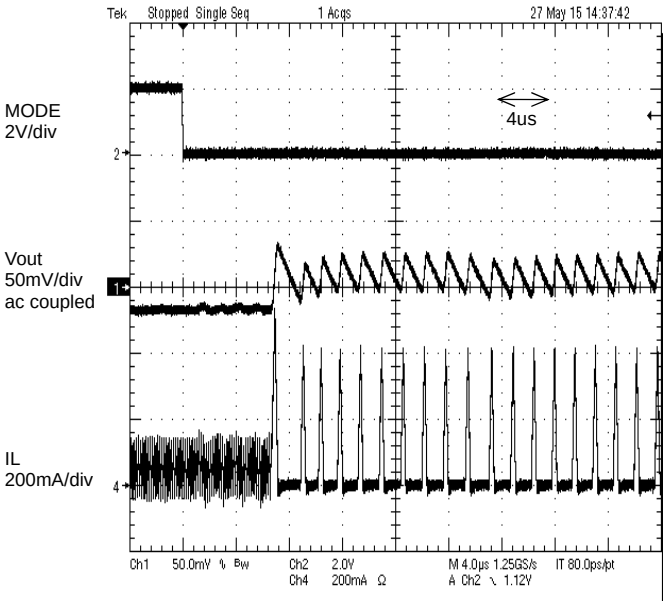


Figure 12. Mode Change Response
MODE : High to Low

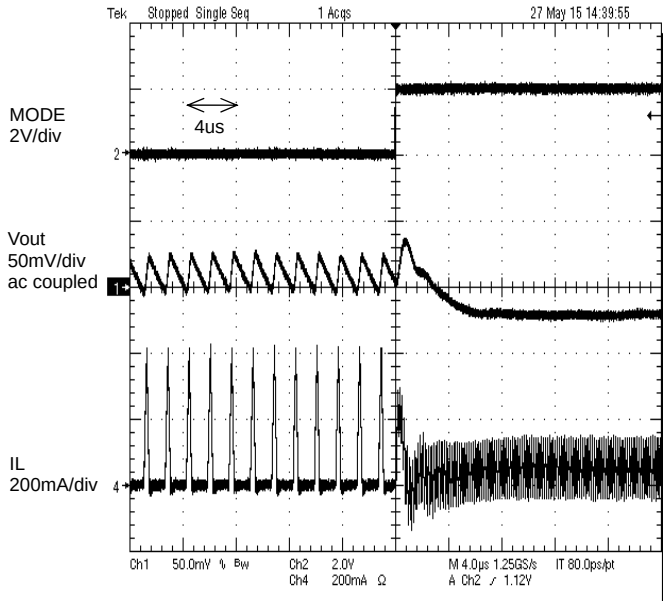


Figure 13. Mode Change Response
MODE : Low to High

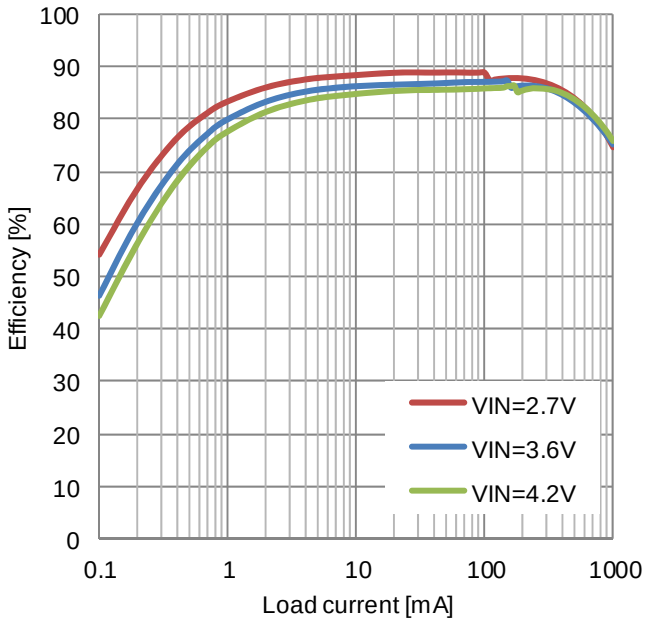


Figure 14. Efficiency vs Load current
PWM/PFM Auto mode

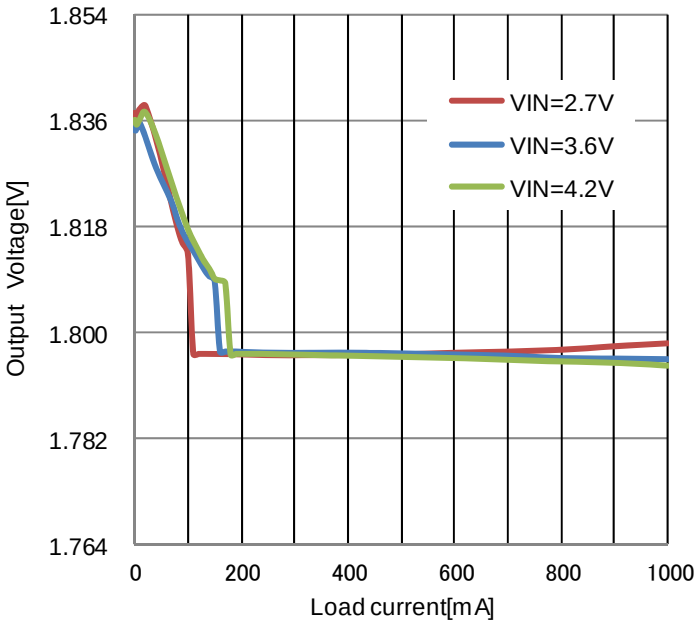


Figure 15. Load regulation
PWM/PFM Auto mode

●PC Board layout

The suggested PCB layout for the BU90104GWZ are shown in Figure. The following guidelines should be used to ensure a proper layout.

1) The input capacitor CIN should be connect as closely possible to VIN pin and GND pin.

2) From the output voltage to the FB pin line should be as separate as possible.

3) COUT and L should be connected as closely as possible. The connection of L to the LX pin should be as short as possible.

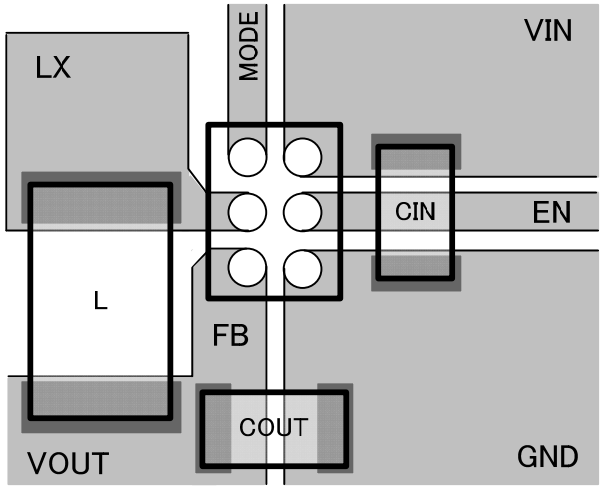


Figure 16. PCB layout

●External parts selection

Inductor selection
The inductance significantly depends on output ripple current. As shown by following equation, the ripple current decreases as the inductor and/or switching frequency increase.

$$\Delta I_L = \frac{(VIN\text{-}VOUT) \times VOUT}{L \times VIN \times f}$$

f: switching frequency L: inductance ΔI_L: inductor current ripple

As a minimum requirement, the DC current rating of the inductor should be equal to the maximum load current plus half of the inductor current ripple as shown by the following equation.

$$I_{LPEAK} = I_{OUTMAX} + \frac{\Delta I_L}{2}$$

1) Recommended inductor selection

・Iout≦1A

LQM2MPN1R0NG0 (2.0mm × 1.6mm × 1.0mm Murata)
MIPSZ2016D1R0FH (2.0mm × 1.6mm × 1.0mm FDK)
DFE252012C1R0 (2.5mm × 2.0mm × 1.2mm TOKO)
DFE252010C1R0 (2.5mm × 2.0mm × 1.0mm TOKO)

・Iout≦0.6A

LQM21PN1R0NGC (2.0mm×1.2mm×1.0mm Murata)
MIPSZ2012D1R0 (2.0mm × 1.2mm × 1.0mm FDK)
MIPSTZ1608D1R0 (1.6mm × 0.8mm × 0.8mm FDK)
MLP2012H1R0M (2.0mm×1.2mm×1.0mm TDK)
CKP2012N1R0N (2.0mm×1.2mm×1.0mm Taiyo Yuden)

2) Recommended input capacitor(CIN) selection

GRM155R60J225M (1.0mm × 0.5mm × 0.5mm Murata)
GRM155R60J475M (1.0mm × 0.5mm × 0.5mm Murata)
GRM155R60G106M (1.0mm × 0.5mm × 0.5mm Murata)

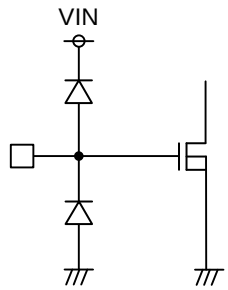
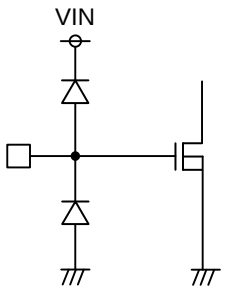
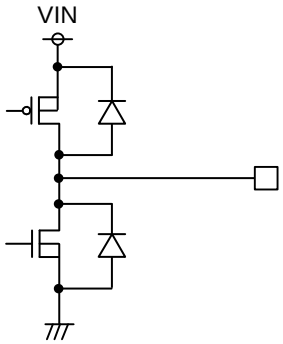
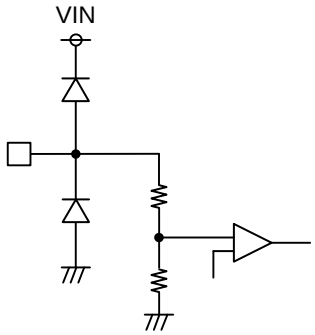
3) Recommended output capacitor(COUT) selection

GRM155R60J475M (1.0mm × 0.5mm × 0.5mm Murata)
GRM155R60G106M (1.0mm × 0.5mm × 0.5mm Murata)

○Cautions on the output capacitor selection

The BU90104GWZ is designed to fixed soft-start time and operate with a maximum output capacitance of (100uF).
If the capacitance connected to the output is larger than (100uF), an overshoot of the output voltage will be caused.
It is possible to cause damage on the connected device.

●I/O equivalence circuit(s)

A2	EN	B1	MODE
			
B2	LX	B3	FB
			

●Caution of use

1) Absolute maximum ratings

An excess in the absolute maximum rating, such as supply voltage, temperature range of operating conditions, etc., can break down the devices, thus making impossible to identify breaking mode, such as a short circuit or an open circuit. If any over rated values will expect to exceed the absolute maximum ratings, consider adding circuit protection devices, such as fuses.

2) GND voltage

The potential of GND pin must be minimum potential in all condition. As an exception, the circuit design allows voltages up to -0.3 V to be applied to the IC pin.

3) Thermal design

Use a thermal design that allows for a sufficient margin in light of the power dissipation (Pd) in actual operating conditions.

4) Inter-pin shorts and mounting errors

Use caution when positioning the IC for mounting on printed circuit boards. The IC may be damaged if there is any connection error or if pins are shorted together.

5) Actions in strong electromagnetic field

Use caution when using the IC in the presence of a strong electromagnetic field as doing so may cause the IC to malfunction.

6) Mutual impedance

Power supply and ground wiring should reflect consideration of the need to lower mutual impedance and minimize ripple as much as possible (by making wiring as short and thick as possible or rejecting ripple by incorporating inductance and capacitance).

7) Thermal shutdown Circuit (TSD Circuit)

This model IC has a built-in TSD circuit. This circuit is only to cut off the IC from thermal runaway, and has not been design to protect or guarantee the IC. Therefore, the user should not plan to activate this circuit with continued operation in mind.

8) Regarding input pin of the IC

This monolithic IC contains P+ isolation and P substrate layers between adjacent elements in order to keep them isolated.

P-N junctions are formed at the intersection of these P layers with the N layers of other elements, creating a parasitic diode or transistor. For example, as shown in the figures below, the relation between each potential is as follows:

When GND > Pin A and GND > Pin B, the P-N junction operates as a parasitic diode.

When GND > Pin B, the P-N junction operates as a parasitic transistor.

Parasitic diodes can occur inevitable in the structure of the IC. The operation of parasitic diodes can result in mutual interference among circuits, operational faults, or physical damage. Accordingly, methods by which parasitic diodes operate, such as applying a voltage that is lower than the GND (P substrate) voltage to an input pin, should not be used.

9) Disturbance light

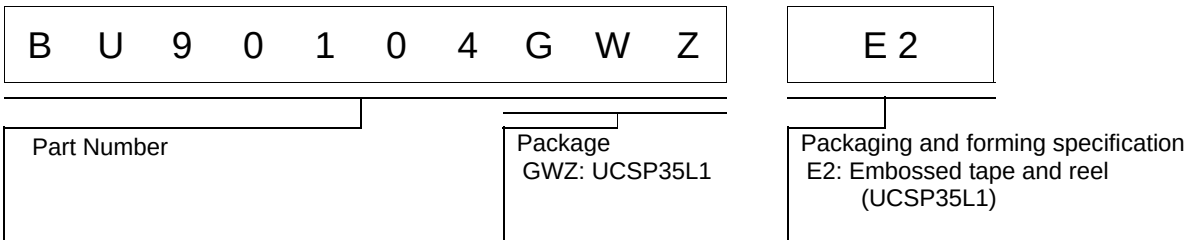
In a device where a portion of silicon is exposed to light such as in a WL-CSP, IC characteristics may be affected due to photoelectric effect. For this reason, it is recommended to come up with countermeasures that will prevent the chip from being exposed to light.

Status of this document

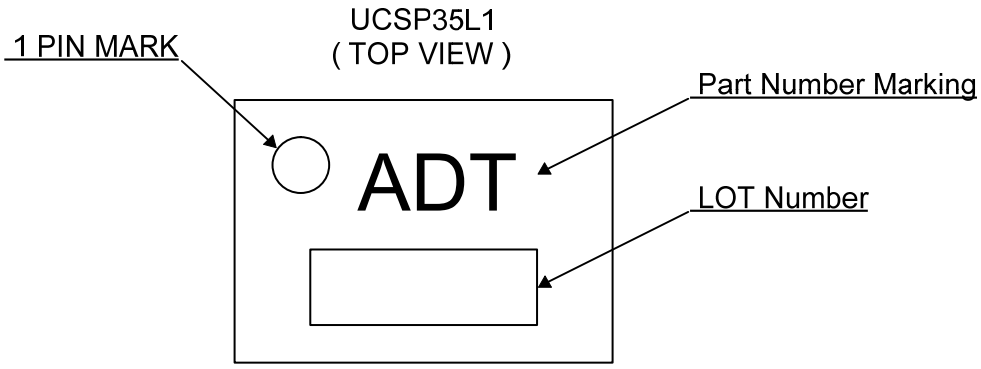
The Japanese version of this document is formal specification. A customer may use this translation version only for a reference to help reading the formal version.

If there are any differences in translation version of this document formal version takes priority

●**Ordering Information**

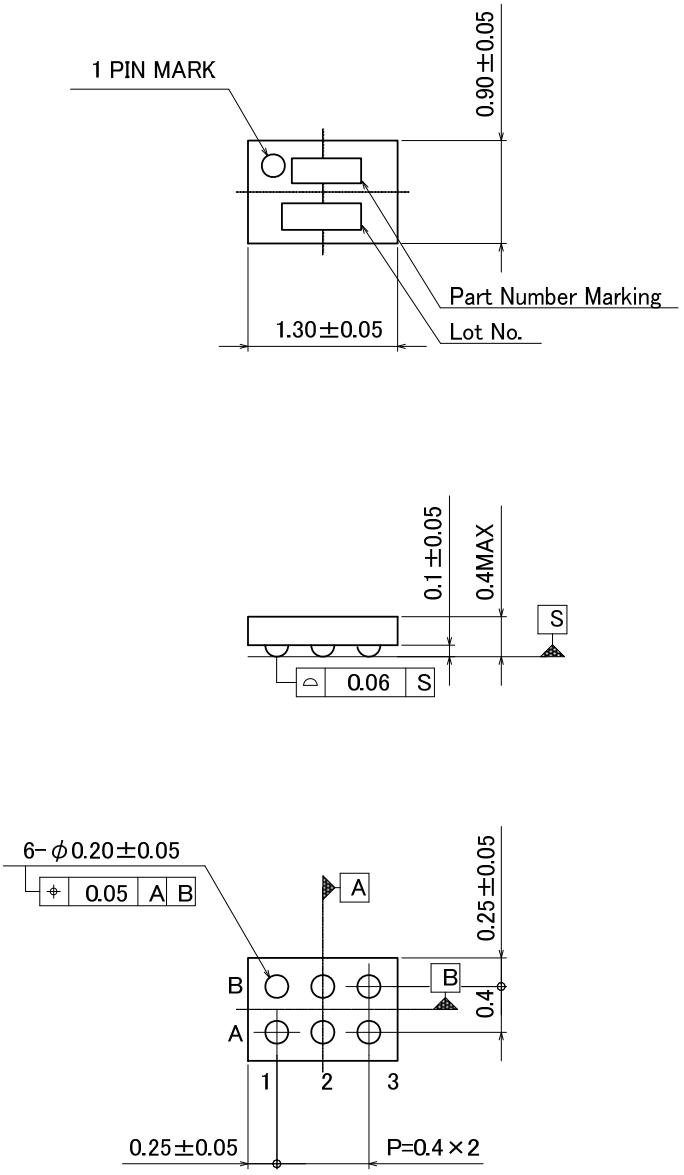


●**Marking Diagram(s)(TOP VIEW)**



●**Physical Dimension Tape and Reel Information**

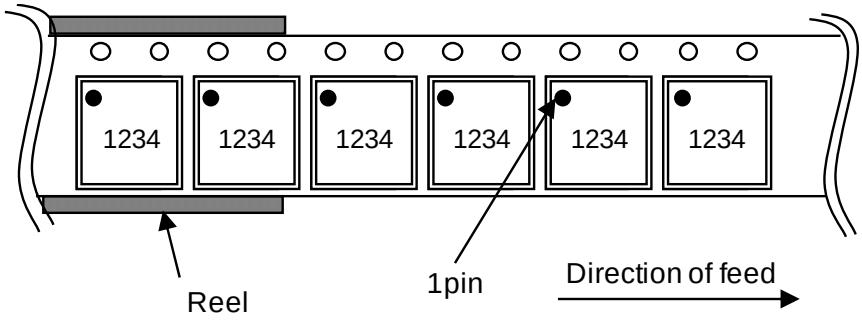
Package Name	UCSP35L1 (BU90104GWZ)



（Unit：mm）

< Tape and Reel Information >

Tape	Embossed carrier tape
Quantity	3000pcs
Direction of feed	E2 The direction is the pin 1 of product is at the upper left when you hold reel on the left hand and you pull out the tape on the right hand



●Revision History

Date	Revision	Changes
22.Jul.2015	001	New Release.

Notice

Precaution on using ROHM Products

1. Our Products are designed and manufactured for application in ordinary electronic equipments (such as AV equipment, OA equipment, telecommunication equipment, home electronic appliances, amusement equipment, etc.). If you intend to use our Products in devices requiring extremely high reliability (such as medical equipment (Note 1), transport equipment, traffic equipment, aircraft/spacecraft, nuclear power controllers, fuel controllers, car equipment including car accessories, safety devices, etc.) and whose malfunction or failure may cause loss of human life, bodily injury or serious damage to property ("Specific Applications"), please consult with the ROHM sales representative in advance. Unless otherwise agreed in writing by ROHM in advance, ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of any ROHM's Products for Specific Applications.

(Note1) Medical Equipment Classification of the Specific Applications

JAPAN	USA	EU	CHINA
CLASSⅢ	CLASSⅢ	CLASSⅡb	CLASSⅢ
CLASSⅣ		CLASSⅢ	

2. ROHM designs and manufactures its Products subject to strict quality control system. However, semiconductor products can fail or malfunction at a certain rate. Please be sure to implement, at your own responsibilities, adequate safety measures including but not limited to fail-safe design against the physical injury, damage to any property, which a failure or malfunction of our Products may cause. The following are examples of safety measures:
   [a] Installation of protection circuits or other protective devices to improve system safety
   [b] Installation of redundant circuits to reduce the impact of single or multiple circuit failure

3. Our Products are designed and manufactured for use under standard conditions and not under any special or extraordinary environments or conditions, as exemplified below. Accordingly, ROHM shall not be in any way responsible or liable for any damages, expenses or losses arising from the use of any ROHM's Products under any special or extraordinary environments or conditions. If you intend to use our Products under any special or extraordinary environments or conditions (as exemplified below), your independent verification and confirmation of product performance, reliability, etc, prior to use, must be necessary:
   [a] Use of our Products in any types of liquid, including water, oils, chemicals, and organic solvents
   [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
   [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl_2, H_2S, NH_3, SO_2, and NO_2
   [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
   [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
   [f] Sealing or coating our Products with resin or other coating materials
   [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
   [h] Use of the Products in places subject to dew condensation

4. The Products are not subject to radiation-proof design.

5. Please verify and confirm characteristics of the final or mounted products in using the Products.

6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.

7. De-rate Power Dissipation (Pd) depending on Ambient temperature (Ta). When used in sealed area, confirm the actual ambient temperature.

8. Confirm that operation temperature is within the specified range described in the product specification.

9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

Precaution for Mounting / Circuit board design

1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.

2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

Precautions Regarding Application Examples and External Circuits

1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.

2. You agree that application notes, reference designs, and associated data and information contained in this document are presented only as guidance for Products use. Therefore, in case you use such information, you are solely responsible for it and you must exercise your own independent verification and judgment in the use of such information contained in this document. ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of such information.

Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of Ionizer, friction prevention and temperature / humidity control).

Precaution for Storage / Transportation

1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
   - [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
   - [b] the temperature or humidity exceeds those recommended by ROHM
   - [c] the Products are exposed to direct sunshine or condensation
   - [d] the Products are exposed to high Electrostatic

2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.

3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.

4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

Precaution for Product Label

QR code printed on ROHM Products label is for ROHM's internal use only.

Precaution for Disposition

When disposing Products please dispose them properly using an authorized industry waste company.

Precaution for Foreign Exchange and Foreign Trade act

Since concerned goods might be fallen under listed items of export control prescribed by Foreign exchange and Foreign trade act, please consult with ROHM in case of export.

Precaution Regarding Intellectual Property Rights

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General Precaution

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